







TUSB4020BI SLLSEI0D - JULY 2015 - REVISED JANUARY 2022

TUSB4020BI Two-Port USB 2.0 Hub

1 Features

- Two-port USB 2.0 hub
- USB 2.0 hub features:
 - Multi-transaction translator (MTT) hub: two transaction translators
 - Four asynchronous endpoint buffers per transaction translator
- Type C compatible
- Supports battery charging
 - CDP mode (upstream port connected)
 - DCP mode (upstream port unconnected)
 - DCP mode complies with chinese telecommunications industry standard YD/T 1591-2009
 - D+/D- divider mode
- Per port or ganged power switching and overcurrent notification inputs
- OTP ROM, serial EEPROM, or I²C/SMBus slave interface for custom configurations:
 - VID and PID
 - Port customizations
 - Manufacturer and product strings (not by OTP)
 - Serial number (not by OTP ROM)
- Application feature selection using terminal selection or EEPROM/ or I2C/SMBus slave interface
- Provides 128-bit universally unique identifier (UUID)
- Supports on-board and in-system OTP/EEPROM programming through the USB 2.0 upstream port
- Single clock input, 24-MHz crystal or oscillator
- No special driver requirements; works seamlessly on any operating system with USB stack support
- 48-Pin HTQFP package (PHP)

2 Applications

- Computer systems
- Docking stations
- Monitors
- Set-top boxes

3 Description

The TUSB4020BI is a two-port USB 2.0 hub. It provides USB high-speed/full-speed connections on the upstream port and provides high-speed, full-speed, or low-speed connections on the two downstream ports. When the upstream port is connected to an electrical environment that supports high-speed and full-speed/low-speed connections, high-speed and full-speed/low-speed USB connectivity is enabled on the downstream ports. When the upstream port is connected to an electrical environment that only supports full-speed/low-speed connections, high-speed connectivity are disabled on the downstream ports.

The TUSB4020BI supports per port or ganged power switching and overcurrent protection.

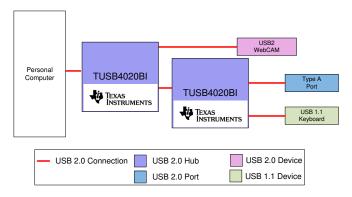
An individually port power controlled hub switches power on or off to each downstream port as requested by the USB host. Also when an individually port power controlled hub senses an over-current event, only power to the affected downstream port will be switched off.

A ganged hub switches on power to all its downstream ports when power is required to be on for any port. The power to the downstream ports is not switched off unless all ports are in a state that allows power to be removed. Also when a ganged hub senses an overcurrent event, power to all downstream ports will be switched off.

Device Information(1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TUSB4020BI	HTQFP (48)	7.00 mm × 7.00 mm

For all available packages, see the orderable addendum at the end of the data sheet



Block Diagram



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NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

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Changes from Revision C (April 2018) to Revision D (January 2	022) Page
Updated the numbering format for tables, figures, and cross-refe	rences throughout the document1
• Removed 1M feedback resistor requirement for crystal on pages	4, 11, 12, and 311
• Updated the pin description from: SMBus slave address bits 2 ar	nd 3 are always 1 for TUSB4020BI to:
SMBus slave address bit 3 is always 1 for TUSB4020Bl	4
• Corrected the default register setting for the Register offset 9h	19
• Updated the Clock, Reset, and Miscellaneous Schematic in the C	Clock, Reset, and Miscellaneous section30
Changes from Revision B (June 2017) to Revision C (April 2018) Page
Changed the Absolute Maximum Ratings table, added pin voltage	es
Changes from Revision A (March 2016) to Revision B (June 201	7) Page
Added SMBUS Programming current to the Hub Input Supply Cu	<i>rrent</i> table8
Added Note to the SMBus Slave Operation section	13
Changes from Revision * (July 2015) to Revision A (March 2016) Page
Deleted Section 1 "DM/DP Polarity Swap"	1



5 Description (continued)

The TUSB4020BI downstream ports provide support for battery charging applications by providing battery charging connected downstream port (CDP) handshaking support. It also supports a dedicated charging port (DCP) mode when the upstream port is not connected. The DCP mode supports USB devices which support the USB Battery Charging and the Chinese Telecommunications Industry Standard YD/T 1591-2009. In addition, an automatic mode provides transparent support for BC devices and devices supporting Divider Mode charging solutions when the upstream port is unconnected.

The TUSB4020BI provides terminal strap configuration for some features including battery charging support, and also provides customization though OTP ROM, I²C EEPROM or through an I²C/SMBus slave interface for PID, VID, and custom port and phy configurations. Custom string support is also available when using an I²C EEPROM or the I²C/SMBus slave interface.

The device is available in a 48-pin HTQFP package and is offered in an industrial version for operation over the temperature range of –40°C to 85°C.



6 Pin Configuration and Functions

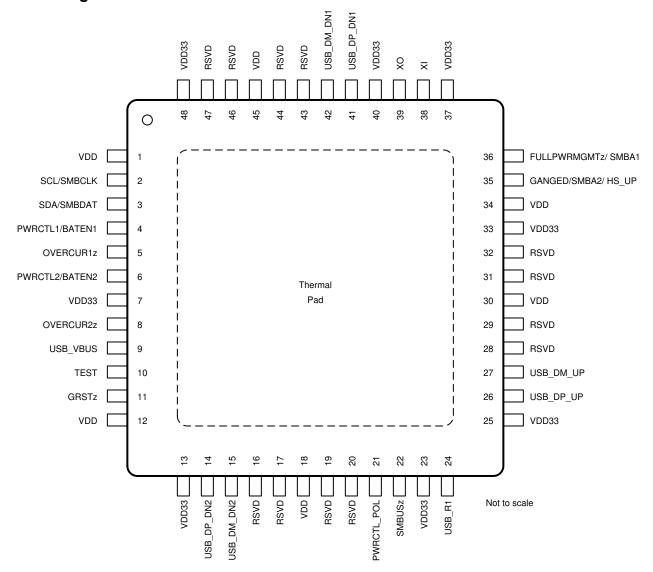


Figure 6-1. PHP Package 48-Pin HTQFP Top View

Table 6-1. Pin Functions

PIN		TYPE ⁽¹⁾	DESCRIPTION			
NAME	NO.	I TPE("	DESCRIPTION			
CLOCK AND RESET SIG	GNALS					
GRSTz	11	I PU	Global power reset. This reset brings all of the TUSB4020BI internal registers to their default states. When GRSTz is asserted, the device is completely nonfunctional.			
XI	38	I	Crystal input. This terminal is the crystal input for the internal oscillator. The input may alternately be driven by the output of an external oscillator.			
хо	39	0	Crystal output. This terminal is the crystal output for the internal oscillator. If XI is driven by an external oscillator this pin may be left unconnected.			
USB UPSTREAM SIGNA	ALS	•				
USB_DP_UP	26	I/O	USB high-speed differential transceiver (positive)			
USB_DM_UP	27	I/O	USB high-speed differential transceiver (negative)			
USB_R1	24	I	Precision resistor reference. A 9.53-kΩ ±1% resistor should be connected between USB_R1 and GND.			
USB_VBUS	9	I	USB upstream port power monitor. The VBUS detection requires a voltage divider. The signal USB_VBUS must be connected to VBUS through a 90.9-k Ω ±1% resistor, and to ground through a 10-k Ω ±1% resistor from the signal to ground.			



Table 6-1. Pin Functions (continued)

PIN		——— (1)					
NAME	NO.	TYPE ⁽¹⁾	DESCRIPTION				
USB DOWNSTREAM S	IGNALS						
USB_DP_DN1	41	I/O	USB high-speed differential transceiver (positive) downstream port 1.				
USB_DM_DN1	42	I/O	USB high-speed differential transceiver (negative) downstream port 1.				
			USB port 1 power-on control for downstream power or battery charging enable. The terminal is used for control of the downstream power switch for Port 1.				
PWRCTL1/BATEN1	4	I/O PD	In addition, the value of the terminal is sampled at the deassertion of reset to determine the value of the battery charging support for Port 1 as indicated in the Battery Charging Support register.				
			0 = Battery charging not supported 1 = Battery charging supported				
			USB DS port 1 overcurrent detection input. This terminal is used to connect the over current output of the downstream port power switch for port 1.				
OVERCUR1z	5	I PU	0 = An overcurrent event has occurred 1 = An overcurrent event has not occurred				
			If power management is enabled, the external circuitry needed should be determined by the power switch. In ganged mode, either OVERCUR1z or OVERCUR2z can be used. In ganged mode, the overcurrent will be reported as a hub event instead of a port event.				
USB_DP_DN2	14	I/O	USB high-speed differential transceiver (positive) downstream port 2.				
USB_DM_DN2	15	I/O	USB high-speed differential transceiver (negative) downstream port 2.				
			Power-on control /battery charging enable for downstream port 2. This terminal is used for control of the downstream power switch for port 2.				
PWRCTL2/BATEN2	N2 6	6 I/O PD	The value of the terminal is sampled at the deassertion of reset to determine the value of the battery charging support for port 2 as indicated in the Battery Charging Support register.				
			0 = Battery charging not supported 1 = Battery charging supported				
			Overcurrent detection for downstream port 2. This terminal is used to connect the over current output of the downstream port power switch for port 2.				
OVERCUR2z	8	I PU	0 = An overcurrent event has occurred 1 = An overcurrent event has not occurred				
			If power management is enabled, the external circuitry needed should be determined by the power switch. In ganged mode either OVERCUR1z or OVERCUR2z can be used. In ganged mode the overcurrent will be reported as a hub event instead of a port event.				
I ² C/SMBUS SIGNALS	•						
			l ² C clock/SMBus clock. Function of terminal depends on the setting of the SMBUSz input.				
			When SMBUSz = 1, this terminal acts as the serial clock interface for an I ² C EEPROM.				
SCL/SMBCLK	2	I/O PD	When SMBUSz = 0, this terminal acts as the serial clock interface for an SMBus host.				
			This pin must be pulled up to use the OTP ROM.				
			Can be left unconnected if external interface not implemented.				
			l ² C data/SMBus data. Function of terminal depends on the setting of the SMBUSz input.				
				When SMBUSz = 1, this terminal acts as the serial data interface for an I ² C EEPROM.			
SDA/SMBDAT	BDAT 3 I/O PD	I/O PD	When SMBUSz = 0, this terminal acts as the serial data interface for an SMBus host.				
			This pin must be pulled up to use the OTP ROM.				
			Can be left unconnected if external interface not implemented.				



Table 6-1. Pin Functions (continued)

TEST AND MISCELLANEOUS SIGNALS SMBUS mode. The value of the terminal is sampled at the deassertion of reset to enable I ² C or SMBus mode. The value of the terminal is sampled at the deassertion of reset to enable I ² C or SMBus mode. 1	PIN			able 6-1. Pin Functions (continued)
SMBUS 2 2 1 UPU 1 PU 1 PU 2 PU 2	NAME	NO.	TYPE ⁽¹⁾	DESCRIPTION
The value of the terminal is sampled at the deassertion of reset to enable I ² C or SMBus mode. 9	TEST AND MISCELLAN	IEOUS SIGNAL	s	
POWER control polarity. Power control polarity. The value of the terminal is sampled at the deassertion of reset to set the polarity of PWRCTL[2:1]. D = PWRCTL polarity is active high. 1 = PWRCTL polarity is active high. 2 After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not be directly to supply but instead pull-up or pull-down using external resistor. Ganged operation enable/SMBus address bit 2/ high-speed status for upstream port. The value of the terminal is sampled at the deassertion of reset to set the power switch and over curre detection mode as follows: 0 = Individual power control supported when power switching is enabled. 1 = Power control gangs supported when power switching is enabled. 1 = Power control gangs supported when power switching is enabled. 2 SMBus slave address bit 3 is always 1 for the TUSB4020BI. 3 After reset, this signal indicates the high-speed USB connection status of the upstream port. A value of 1 indicates the upstream port is connected to a high-speed USB capable port. Note: Individual power control must be enabled for battery charging applications. Full power management made be enabled for battery charging applications. Full power management is the ability to control power to the downstream ports of the TUSB4020BI using PWRCTL[2:1]BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 3 is always 1 for the TUSB4020BI. Due to this behavior, it is recommended to not be directly to supply but instead pull-up or pull-down using external resistor. RSVD 20, 28, 29, 20, 20, 20, 20, 20, 20, 20, 20, 20, 20	SMBUSz	22	l PU	The value of the terminal is sampled at the deassertion of reset to enable I ² C or SMBus mode. 0 = SMBus mode selected 1 = I ² C mode selected After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not
The value of the terminal is sampled at the deassertion of reset to set the polarity of PWRCTL[2:1]. 0 = PWRCTL polarity is active high. 1 = PWRCTL polarity is active high. 2 = PWRCTL polarity is active high. 3 = PWRCTL polarity is active high.				7 117 1 1
tie directly to supply but instead pull-up or pull-down using external resistor. Ganged operation enable/SMBus address bit 2/ high-speed status for upstream port The value of the terminal is sampled at the deassertion of reset to set the power switch and over curre detection mode as follows: 0 = Individual power control supported when power switching is enabled. 1 = Power control gangs supported when power switching is enabled. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 3 is always 1 for the TUSB4020B1. After reset, this signal indicates the high-speed USB connection status of the upstream port. A value of 1 indicates the upstream port is connected to a high-speed USB capable port. Note: Individual power control must be enabled for battery charging applications. Full power management enable/ SMBus Address bit 1. The value of the terminal is sampled at the deassertion of reset to set the power switch control follows 0 = Power switching supported 1 = Power switching supported 1 = Power switching supported Full power management is the ability to control power to the downstream ports of the TUSB4020B1 using PVMCTIL(2:1)BATEN(2:1). When SMBus made is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 3 is always 1 for the TUSB4020B1. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020B1 use to this behavior, it is recommended to not tell directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD 20, 28, 29, 31, 32, 43, 44, 46, 47 TEST 10 PD TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 33, 40, 48 PWR 3,3-V power rail	PWRCTL_POL	21		The value of the terminal is sampled at the deassertion of reset to set the polarity of PWRCTL[2:1]. 0 = PWRCTL polarity is active high. 1 = PWRCTL polarity is active low.
The value of the terminal is sampled at the deassertion of reset to set the power switch and over curre detection mode as follows: 0 = Individual power control supported when power switching is enabled. 1 = Power control gangs supported when power switching is enabled. 1 = Power control gangs supported when power switching is enabled. 1 = Power control gangs supported when power switching is enabled. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 3: a slavays 1 for the TUSB4020BI. After reset, this signal indicates the high-speed USB connection status of the upstream port. A value of 1 indicates the upstream port is connected to a high-speed USB capable port. Note: Individual power control must be enabled of statery charging applications. Full power management enable/ SMBus Address bit 1. The value of the terminal is sampled at the deassertion of reset to set the power switch control follows 0 = Power switching not supported Full power management is the ability to control power to the downstream ports of the TUSB4020BI using PWRCTL[2:1]BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not itie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD 20, 28, 29, 31, 32, 43, 44, 46, 47 TEST 10 PD Reserved. These pins are for internal use only and should be left unconnected on PCB. TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 PWR 3.3-V power rail 3.3-V power rail				tie directly to supply but instead pull-up or pull-down using external resistor.
SANGED/SMBA2/ HS_UP 1 = Power control gangs supported when power switching is enabled. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 3: a laways 1 for the TUSB4020BI. After reset, this signal indicates the high-speed USB connection status of the upstream port. A value of 1 indicates the upstream port is connected to a high-speed USB capable port. Note: Individual power control must be enabled for battery charging applications. Full power management enable/ SMBus Address bit 1. The value of the terminal is sampled at the deassertion of reset to set the power switch control follows 0 = Power switching not supported 1 = Power switching not supported 1 = Power switching not supported 1 = Power switching pwported 1 = Power switching not supported 1 = SMBus Address bit 1. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave addres bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tild directly to supply but instead pull-lup or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. TEST 10 Reserved. These pins are for internal use only and should be left unconnected on PCB. TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 PWR 3,3-V power rail 3,3-V power rail				The value of the terminal is sampled at the deassertion of reset to set the power switch and over current
When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 3 is always 1 for the TUSB4020BI. After reset, this signal indicates the high-speed USB connection status of the upstream port. A value of 1 indicates the upstream port is connected to a high-speed USB capable port. Note: Individual power control must be enabled for battery charging applications. Full power management enable/ SMBus Address bit 1. The value of the terminal is sampled at the deassertion of reset to set the power switch control follows 0 = Power switching supported 1 = Power switching supported 1 = Power switching not supported 1 = Power switching supported 1 = SWBUSz, this terminal is sets the value of the SMBus slave addres bit 1. SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tell directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. TEST 10 PD Reserved. These pins are for internal use only and should be left unconnected on PCB. TEST 10 PD TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 11, 12, 18, 30, 34, 45 PWR 3.3-V power rail 3.3-V power rail		35	1	1 1 1
1 indicates the upstream port is connected to a high-speed USB capable port. Note: Individual power control must be enabled for battery charging applications. Full power management enable/ SMBus Address bit 1. The value of the terminal is sampled at the deassertion of reset to set the power switch control follows 0 = Power switching supported 1 = Power switching not supported Full power management is the ability to control power to the downstream ports of the TUSB4020BI using PWRCTL[2:1]BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1: SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not itie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. TEST 10 Reserved. These pins are for internal use only and should be left unconnected on PCB. TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 3, 37, 40, 48 PWR 3.3-V power rail PWR 3.3-V power rail	HS_UP		PU	When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 2. SMBus slave address bit 3 is always 1 for the TUSB4020BI.
FULLPWRMGMTz/ SMBA1 36 I, PU I, PU FULLPWRMGMTz/ SMBA1 36 I, PU I, PU FULLPWRMGMTz/ SMBA1 36 I, PU FULLPWRMGMTz/ SMBA1 36 I, PU FULLPWRMGMTz/ SMBA1 36 I, PU Full power management is the ability to control power to the downstream ports of the TUSB4020BI using PWRCTL[2:1]/BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD 16, 17, 19, 20, 28, 29, 31, 32, 43, 44, 46, 47 TEST 10 1 PD TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45, 34, 45 VDD 7, 13, 23, 25, 33, 37, 40, 48 PWR 3,3-V power rail				After reset, this signal indicates the high-speed USB connection status of the upstream port. A value of 1 indicates the upstream port is connected to a high-speed USB capable port.
The value of the terminal is sampled at the deassertion of reset to set the power switch control follows 0 = Power switching supported 1 = Power switching not supported Full power management is the ability to control power to the downstream ports of the TUSB4020BI using PWRCTL[2:1]/BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD 16, 17, 19, 20, 28, 29, 31, 32, 43, 44, 46, 47 TEST 10 PD TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45, 34, 45, 34, 45, 37, 13, 23, 25, 33, 37, 40, 48 PWR 1.1-V power rail 1.1-V power rail				Note: Individual power control must be enabled for battery charging applications.
FULLPWRMGMTz/ SMBA1 36 I, PU FULLPWRMGMTz/ SMBA1 36 I, PU Full power management is the ability to control power to the downstream ports of the TUSB4020BI using PWRCTL[2:1]/BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. Reserved. These pins are for internal use only and should be left unconnected on PCB. TEST 10 I TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 PWR 1.1-V power rail 3.3-V power rail				Full power management enable/ SMBus Address bit 1.
FULLPWRMGMTz/ SMBA1 36 I, PU I, PU				The value of the terminal is sampled at the deassertion of reset to set the power switch control follows:
FULLPWRMGMTz/ SMBA1 36 I, PU using PWRCTL[2:1]/BATEN[2:1]. When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave addres bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD 16, 17, 19, 20, 28, 29, 31, 32, 43, 44, 46, 47 Reserved. These pins are for internal use only and should be left unconnected on PCB. TEST 10 I TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 PWR 1.1-V power rail 7, 13, 23, 25, 33, 37, 40, 48 PWR 3.3-V power rail				
SMBA1 SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI. Can be left unconnected if full power management and SMBus are not implemented. After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD	FULLPWRMGMTz/			
After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. RSVD 16, 17, 19, 20, 28, 29, 31, 32, 43, 44, 46, 47 TEST 10 TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 PWR 1.1-V power rail VDD33 7, 13, 23, 25, 33, 37, 40, 48 PWR 3.3-V power rail		36	I, PU	When SMBus mode is enabled using SMBUSz, this terminal sets the value of the SMBus slave address bit 1. SMBus slave address bit 3 is always 1 for the TUSB4020BI.
tie directly to supply but instead pull-up or pull-down using external resistor. Note: Power switching must be supported for battery charging applications. 16, 17, 19, 20, 28, 29, 31, 32, 43, 44, 46, 47				Can be left unconnected if full power management and SMBus are not implemented.
RSVD 16, 17, 19, 20, 28, 29, 31, 32, 43, 44, 46, 47 TEST 10 I TEST mode enable. When this terminal is asserted high at reset enables test mode. This terminal is reserved for factory use. It is recommended to pull-down this terminal to ground. POWER AND GROUND SIGNALS VDD 1, 12, 18, 30, 34, 45 PWR 1.1-V power rail VDD33 7, 13, 23, 25, 33, 37, 40, 48 PWR 3.3-V power rail				After reset, this signal is driven low by the TUSB4020BI. Due to this behavior, it is recommended to not tie directly to supply but instead pull-up or pull-down using external resistor.
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PD reserved for factory use. It is recommended to pull-down this terminal to ground.	RSVD	20, 28, 29, 31, 32, 43,	I/O	Reserved. These pins are for internal use only and should be left unconnected on PCB.
VDD 1, 12, 18, 30, 34, 45 PWR 1.1-V power rail VDD33 7, 13, 23, 25, 33, 37, 40, 48 PWR 3.3-V power rail	TEST	10		
VDD3 34, 45 PWR 1.1-V power rail VDD33 7, 13, 23, 25, 33, 37, 40, 48 PWR 3.3-V power rail	POWER AND GROUND	SIGNALS		
33, 37, 40, 48 PWR 3.3-V power rail	VDD		PWR	1.1-V power rail
GND PAD — Ground	VDD33		PWR	3.3-V power rail
1	GND		_	Ground

⁽¹⁾ I = input, O = output, I/O = input/output, PU = internal pullup resistor, PD = internal pulldown resistor, and PWR = power signal

7 Specifications

7.1 Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature (unless otherwise noted)

		MIN	MAX	UNIT
Cumply \/altaga	V _{DD} Steady-state supply voltage	-0.3	1.4	V
Supply Voltage	V _{DD33} Steady-state supply voltage	-0.3	3.8	V
	USB_VBUS pin	-0.3	1.4	V
Voltage	XI pins	-0.3	2.45	V
	All other pins	-0.3	3.8	V
T _{stg}	Storage temperature	-65	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
V.===:	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	±4000	\ \/
V _(ESD)	discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾	±1500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
VDD ⁽¹⁾	1.1-V supply voltage	0.99	1.1	1.26	V
VDD33	3.3-V supply voltage	3	3.3	3.6	V
USB_VBUS	Voltage at USB_VBUS pin	0		1.155	V
T _A	Operating free-air temperature range	-40	25	85	°C
T _J	Operating junction temperature range	-40	25	105	°C

⁽¹⁾ A 1.05-V, 1.1-V, or 1.2-V supply may be used as long as minimum and maximum supply conditions are met.

7.4 Thermal Information

		TUSB4020BI		
	THERMAL METRIC ⁽¹⁾	PHP (HTQFP)	UNIT	
		48 PINS		
R _{0 JA}	Junction-to-ambient thermal resistance	31.8	°C/W	
R _{θ JC(top)}	Junction-to-case (top) thermal resistance	16.1	°C/W	
R _{θ JB}	Junction-to-board thermal resistance	13	°C/W	
ΨЈТ	Junction-to-top characterization parameter	0.5	°C/W	
ΨЈВ	Junction-to-board characterization parameter	12.9	°C/W	
R _{θ JC(bot)}	Junction-to-case (bottom) thermal resistance	0.9	°C/W	

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



7.5 3.3-V I/O Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	OPERATION	TEST CONDITIONS	MIN	TYP MAX	UNIT
V _{IH}	High-level input voltage ⁽¹⁾	VDD33		2	VDD33	V
V _{IL}	Low-level input voltage ⁽¹⁾	VDD33		0	0.8	V
Vı	Input voltage			0	VDD33	V
Vo	Output voltage ⁽²⁾			0	VDD33	V
t _t	Input transition time (t _{rise} and t _{fall})			0	25	ns
V _{hys}	Input hysteresis ⁽³⁾				0.13 × VDD33	V
V _{OH}	High-level output voltage	VDD33	I _{OH} = -4 mA	2.4		V
V _{OL}	Low-level output voltage	VDD33	I _{OL} = 4 mA		0.4	V
I _{OZ}	High-impedance, output current ⁽²⁾	VDD33	V _I = 0 to VDD33		±20	μA
I _{OZP}	High-impedance, output current with internal pullup or pulldown resistor ⁽⁴⁾	VDD33	V _I = 0 to VDD33		±225	μΑ
I _I	Input current ⁽⁵⁾	VDD33	V _I = 0 to VDD33		±15	μA

- (1) Applies to external inputs and bidirectional buffers
- (2) (3) Applies to external outputs and bidirectional buffers
- Applies to GRSTz
- Applies to pins with internal pullups/pulldowns (4)
- (5) Applies to external input buffers

7.6 Hub Input Supply Current

typical values measured at $T_A = 25^{\circ}C$

PARAMETER	VDD33	VDD11	UNIT				
FARAMETER	3.3 V	1.1 V	UNII				
LOW-POWER MODES							
Power-on (after reset)	5	39	mA				
Disconnect from host	5	39	mA				
Suspend	5	39	mA				
ACTIVE MODES (US STATE / DS STATE)							
2.0 host / 1 HS device active	48	71	mA				
2.0 host / 2 HS devices active	60	80	mA				
SMBUS Programming current	79	225	mA				

7.7 Power-Up Timing Requirements

		MIN	NOM	MAX	UNIT
t _{d1}	VDD33 stable before VDD stable ⁽¹⁾	see (2)			ms
t _{d2}	VDD and VDD33 stable before deassertion of GRSTz	3			ms
t _{su_io}	Setup for MISC inputs ⁽³⁾ sampled at the deassertion of GRSTz	0.1			μs
t _{hd_io}	Hold for MISC inputs ⁽³⁾ sampled at the deassertion of GRSTz.	0.1			μs
t _{VDD33_RAMP}	VDD33 supply ramp requirements	0.2		100	ms
t _{VDD_RAMP}	VDD supply ramp requirements	0.2		100	ms

- (1) An active reset is required if the VDD33 supply is stable before the VDD11 supply. This active Reset shall meet the 3ms power-up delay counting from both power supplies being stable to the de-assertion of GRSTz.
- (2) There is no power-on relationship between VDD33 and VDD unless GRSTz is only connected to a capacitor to GND. Then VDD must be stable minimum of 10 µs before the VDD33.
- (3) MISC pins sampled at deassertion of GRSTz: FULLPWRMGMTz, GANGED, PWRCTL_POL, SMBUSz, BATEN[4:1], and AUTOENz.

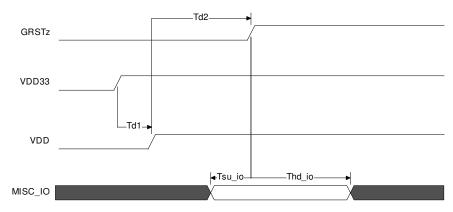


Figure 7-1. Power-Up Timing Requirements

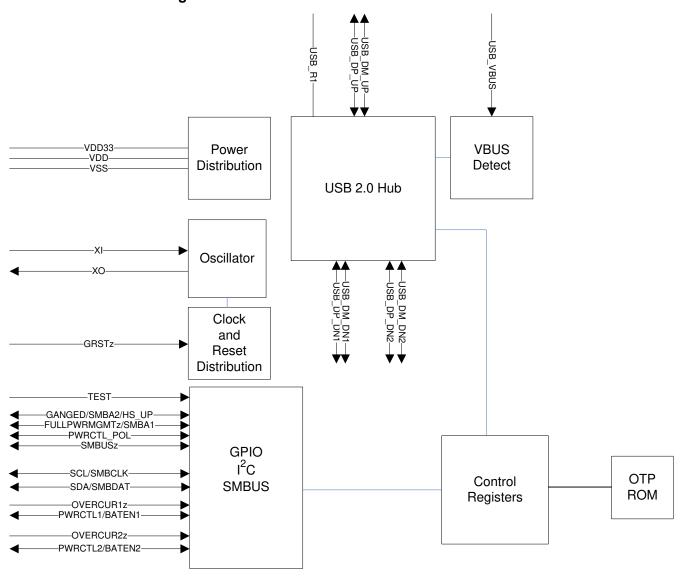


8 Detailed Description

8.1 Overview

The TUSB4020BI is a two-port USB 2.0 hub. It provides USB high-speed/full-speed connections on the upstream port and provides USB high-speed, full-speed, or low-speed connections on the downstream ports. When the upstream port is connected to an electrical environment that supports high-speed and full-speed/low-speed connections, USB high-speed and full-speed/low-speed connectivity is enabled on the downstream ports. When the upstream port is connected to an electrical environment that only supports full-speed/low-speed connections, USB high-speed connectivity are disabled on the downstream ports.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Battery Charging Features

The TUSB4020BI provides support for battery charging. Battery charging support may be enabled on a per port basis through the REG_6h(batEn[1:0]).

Battery charging support includes both charging downstream port (CDP) and dedicated charging port (DCP) modes. The DCP mode is compliant with the Chinese Telecommunications Industry Standard YD/T 1591-2009.

In addition to standard DCP mode, the TUSB4020BI provides a mode (AUTOMODE) which automatically provides support for DCP devices and devices that support custom charging indication. AUTOMODE is disabled by default. When in AUTOMODE, the port automatically switches between a divider mode and the DCP mode depending on the portable device connected. The divider mode places a fixed DC voltage on the ports DP and DM signals which allows some devices to identify the capabilities of the charger. The default divider mode indicates support for up to 5 W. The divider mode can be configured to report a high-current setting (up to 10 W) through REG_Ah(HiCurAcpModeEn). When AUTOMODE is enabled through REG_Ah(autoModeEnz), the CDP mode is not functional. CDP mode can not be used when AUTOMODE is enabled.

The battery charging mode for each port depends on the state of Reg_6h(batEn[n]), the status of the VBUS input, and the state of REG_Ah(autoModeEnz) upstream port, as identified in Table 8-1. Battery charging can also be enabled through the PWRCTL1/BATEN1 and PWRCTL2/BATEN2 pins.

Table 8-1. TUSB4020BI Battery Charging Modes

batEn[n]	VBUS	autoModeEnz	BC Mode Port x (x = n + 1)
0	Do not care	Do not care	Do not care
	<4 V	0	Automode ⁽³⁾ (4)
1	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	1	DCP ⁽¹⁾ (2)
	>4 V	1	CDP ⁽¹⁾

- (1) USB device is USB Battery Charging Specification Revision 1.2 Compliant
- (2) USB device is Chinese Telecommunications Industry Standard YD/T 1591-2009
- (3) Auto-mode automatically selects divider-mode or DCP mode.
- (4) Divider mode can be configured for high-current mode through register or OTP settings.

8.3.2 USB Power Management

The TUSB4020BI can be configured for power switched applications using either per-port or ganged power-enable controls and overcurrent status inputs.

Power switch support is enabled by REG_5h(fullPwrMgmtz) and the per-port or ganged mode is configured by REG_5h(ganged). It can also be enabled through the FULLPWRMGMTz pin. Also ganged or individual control can be controlled by the GANGED pin.

The TUSB4020BI supports both active-high and active-low power-enable controls. The PWRCTL[2:1] polarity is configured by REG_Ah(pwrctlPol). The polarity can also be configured by the PWRCTL_POL pin.

8.3.3 Clock Generation

The TUSB4020BI accepts a crystal input to drive an internal oscillator or an external clock source. Keep the XI and XO traces as short as possible and away from any switching leads to minimize noise coupling.



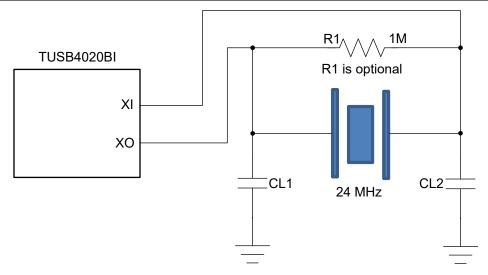


Figure 8-1. TUSB4020BI Clock

8.3.4 Power-Up and Reset

The TUSB4020BI does not have specific power sequencing requirements with respect to the VDD or VDD33 power rails. The VDD or VDD33 power rails may be powered up for an indefinite period of time while the other is not powered up if all of these constraints are met:

- All maximum ratings and recommended operating conditions are observed.
- All warnings about exposure to maximum rated and recommended conditions are observed, particularly junction temperature. These apply to power transitions as well as normal operation.
- Bus contention while VDD33 is powered-up must be limited to 100 hours over the projected lifetime of the
 device.
- Bus contention while VDD33 is powered-down may violate the absolute maximum ratings.

A supply bus is powered up when the voltage is within the recommended operating range. A supply bus is powered down when it is below that range, either stable or in transition.

A minimum reset duration of 3 ms is required, which is defined as the time when the power supplies are in the recommended operating range to the deassertion of GRSTz. This can be generated using programmable-delay supervisory device or using an RC circuit.

8.4 Device Functional Modes

8.4.1 External Configuration Interface

The TUSB4020BI supports a serial interface for configuration register access. The device may be configured by an attached I²C EEPROM or accessed as a slave by a SMBus-capable host controller. The external interface is enabled when both the SCL/SMBCLK and SDA/SMBDAT terminals are pulled up to 3.3 V at the deassertion of reset. The mode, I²C master, or SMBus slave is determined by the state of SMBUSz terminal at reset.

8.5 Programming

8.5.1 One-Time Programmable (OTP) Configuration

The TUSB4020BI allows device configuration through OTP non-volatile memory (OTP). The programming of the OTP is supported using vendor-defined USB device requests. For details using the OTP features, contact your TI representative.

Table 8-2 provides a list features which may be configured using the OTP. The bit field section in Table 8-2 shows which features can be controlled by OTP ROM. The bits not listed in the table are not accessible by the OTP ROM.

Table 8-2. OTP Configurable Features

CONFIGURATION REGISTER OFFSET	BIT FIELD	DESCRIPTION
REG_01h	[7:0]	Vendor ID LSB
REG_02h	[7:0]	Vendor ID MSB
REG_03h	[7:0]	Product ID LSB
REG_04h	[7:0]	Product ID MSB
REG_07h	[0]	Port removable configuration for downstream ports 1. OTP configuration is inverse of rmbl[1:0], that is: 1 = Not removable 0 = Removable
REG_07h	[1]	Port removable configuration for downstream ports 2. OTP configuration is inverse of rmbl[1:0], that is: 1 = Not removable 0 = Removable
REG_0Ah	[1]	Automode enable
REG_0Ah	[4]	High-current divider mode enable.
REG_F2h	[3:1]	USB power switch power-on delay.

8.5.2 I²C EEPROM Operation

The TUSB4020BI supports a single-master, standard mode (100 kbit/s) connection to a dedicated I²C EEPROM when the I²C interface mode is enabled. In I²C mode, the TUSB4020BI reads the contents of the EEPROM at bus address 1010000b using 7-bit addressing starting at address 0.

If the value of the EEPROM contents at byte 00h equals 55h, the TUSB4020BI loads the configuration registers according to the EEPROM map. If the first byte is not 55h, the TUSB4020BI exits the I²C mode and continues execution with the default values in the configuration registers. The hub will not connect on the upstream port until the configuration is completed. If the TUSB4020BI detects an unprogrammed EEPROM (value other than 55h), it enters programming mode and a programming endpoint within the hub is enabled.

Note, the bytes located above offset Ah are optional. The requirement for data in those addresses depends on the options configured in the Device Configuration, Phy Custom Configuration, and Device Configuration 2 registers.

For details on I²C operation, refer to the UM10204 I²C-bus Specification and User Manual.

8.5.3 SMBus Slave Operation

When the SMBus interface mode is enabled, the TUSB4020BI supports read block and write block protocols as a slave-only SMBus device.

The TUSB4020BI slave address is 1000 1xyz, where:

- x is the state of GANGED/SMBA2/HS_UP terminal at reset
- y is the state of FULLPWRMGMTz/SMBA1 terminal at reset
- z is the read/write bit; 1 = read access, 0 = write access.



If the TUSB4020BI is addressed by a host using an unsupported protocol, it does not respond. The TUSB4020BI waits indefinitely for configuration by the SMBus host and does not connect on the upstream port until the SMBus host indicates configuration is complete by clearing the CFG_ACTIVE bit.

For details on SMBus requirements, refer to the System Management Bus Specification.

Note

During the SMBUS configuration the hub may draw an extra current, this extra current consumption will end as soon as the CFG_ACTIVE bit is cleared. For more information, see <u>Section 7.6</u> Section in this datasheet.

8.6 Register Maps

8.6.1 Configuration Registers

The internal configuration registers are accessed on byte boundaries. The configuration register values are loaded with defaults but can be overwritten when the TUSB4020BI is in I²C or SMBus mode.

Table 8-3. TUSB4020BI Register Map

BYTE ADDRESS	CONTENTS	EEPROM CONFIGURABLE
00h	ROM Signature Register	No
01h	Vendor ID LSB	Yes
02h	Vendor ID MSB	Yes
03h	Product ID LSB	Yes
04h	Product ID MSB	Yes
05h	Device Configuration Register	Yes
06h	Battery Charging Support Register	Yes
07h	Device Removable Configuration Register	Yes
08h	Port Used Configuration Register	Yes
09h	Reserved	Yes, program to 00h
0Ah	Device Configuration Register 2	Yes
0Bh to 0Fh	Reserved	
10h to 1Fh	UUID Byte [15:0]	No
20h to 21h	LangID Byte [1:0]	Yes, if customStrings is set
22h	Serial Number String Length	Yes, if customSerNum is set
23h	Manufacturer String Length	Yes, if customStrings is set
24h	Product String Length	Yes, if customStrings is set
25h to 2Fh	Reserved	Yes
30h to 4Fh	Serial Number String Byte [31:0]	Yes, if customSerNum is set
50h to 8Fh	Manufacturer String Byte [63:0]	Yes, if customStrings is set
90h to CFh	Product String Byte [63:0]	Yes, if customStrings is set
D0 to DFh	Reserved	No
F0h	Additional Feature Configuration Register	Yes
F1h	Reserved	Yes
F2h	Charging Port Control Register	Yes
F3 to F7h	Reserved	No
F8h	Device Status and Command Register	No
F9 to FFh	Reserved	No

8.6.1.1 ROM Signature Register (offset = 0h) [reset = 0h]

Figure 8-2. Register Offset 0h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-4. ROM Signature Register

Bit	Field	Туре	Reset Description		
7:0	romSignature	R/W	0h	ROM Signature Register. This register is used by the TUSB4020BI in I ² C mode to validate the attached EEPROM has been programmed. The first byte of the EEPROM is compared to the mask 55h and if not a match, the TUSB4020BI aborts the EEPROM load and executes with the register defaults.	

8.6.1.2 Vendor ID LSB Register (offset = 1h) [reset = 51h]

Figure 8-3. Register Offset 51h

7	6	5	4	3	2	1	0
0	1	0	1	0	0	0	1
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-5. Vendor ID LSB Register

_					
	Bit	Field	Туре	Reset	Description
	7:0	vendorldLsb	R/W	51h	Vendor ID LSB. Least significant byte of the unique vendor ID assigned by the USB-IF; the default value of this register is 51h representing the LSB of the TI Vendor ID 0451h. The value may be overwritten to indicate a customer vendor ID. This field is read/write unless the OTP ROM VID and OTP ROM PID values are non-zero. If both values are non-zero, the value when reading this register shall reflect the OTP ROM value.

8.6.1.3 Vendor ID MSB Register (offset = 2h) [reset = 4h]

Figure 8-4. Register Offset 2h

7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-6. Vendor ID MSB Register

Bit	Field	Туре	Reset	Description
7:0	vendorldMsb	R/W	4h	Vendor ID MSB. Most significant byte of the unique vendor ID assigned by the USB-IF; the default value of this register is 04h representing the MSB of the TI Vendor ID 0451h. The value may be overwritten to indicate a customer vendor ID. This field is read/write unless the OTP ROM VID and OTP ROM PID values are non-zero. If both values are non-zero, the value when reading this register shall reflect the OTP ROM value.



8.6.1.4 Product ID LSB Register (offset = 3h) [reset = 25h]

Figure 8-5. Register Offset 3h

7	6	5	4	3	2	1	0
0	0	1	0	0	1	0	1
R/W							

LEGEND: R/W = Read/Write; R = Read only; –n = value after reset

Table 8-7. Product ID LSB Register

Bit	Field	Туре	Reset	Description
7:0	productIdLsb	R/W	25h	Product ID LSB. Least significant byte of the product ID assigned by TI. The default value of this register is 25h representing the LSB of the product ID assigned by TI. The value reported in the USB 2.0 device descriptor is the value of this register bit wise XORed with 00000010b. The value may be overwritten to indicate a customer product ID. This field is read/write unless the OTP ROM VID and OTP ROM PID values are non-zero. If both values are non-zero, the value when reading this register shall reflect the OTP ROM value.

8.6.1.5 Product ID MSB Register (offset = 4h) [reset = 80h]

Figure 8-6. Register Offset 4h

7	6	5	4	3	2	1	0
1	0	0	0	0	0	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-8. Bit Descriptions - Product ID MSB Register

Bit	Field	Туре	Reset	Description
7:0	productIdLsb	R/W	80h	Product ID MSB. Most significant byte of the product ID assigned by TI; the default value of this register is 80h representing the MSB of the product ID assigned by TI. The value may be overwritten to indicate a customer product ID. This field is read/write unless the OTP ROM VID and OTP ROM PID values are non-zero. If both values are non-zero, the value when reading this register will reflect the OTP ROM value.

8.6.1.6 Device Configuration Register (offset = 5h) [reset = 1Xh]

Figure 8-7. Register Offset 5h

7	6	5	4	3	2	1	0
0	0	0	1	Х	Х	0	0
R/W	R/W	R/W	R	R/W	R/W	R/W	R

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-9. Device Configuration Register

Bit	Field	Туре	Reset	Description
7	customStrings	R/W	1Xh	Custom strings enable. This bit controls the ability to write to the Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers. 0 = The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers are read only. 1 = The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers may be loaded by EEPROM or written by SMBus.
6	customSernum	R/W	1Xh	The default value of this bit is 0. Custom serial number enable. This bit controls the ability to write to the serial number registers. 0 = The Serial Number String Length and Serial Number String registers are read only. 1 = The Serial Number String Length and Serial Number String registers may be loaded by EEPROM or written by SMBus. The default value of this bit is 0.
5	RSVD	R/W	1Xh	Reserved. This bit is reserved.
4	RSVD	R	1Xh	Reserved. This bit is reserved and returns 1 when read.
3	ganged	R/W	1Xh	Ganged. This bit is loaded at the deassertion of reset with the value of the GANGED/SMBA2/HS_UP terminal. 0 = When fullPwrMgmtz = 0, each port is individually power switched and enabled by the PWRCTL[2:1]/BATEN[2:1] terminals 1 = When fullPwrMgmtz = 0, the power switch control for all ports is ganged and enabled by the PWRCTL1/BATEN1 terminal When the TUSB4020BI is in I ² C mode, the TUSB4020BI loads this bit from the contents of the EEPROM. When the TUSB4020BI is in SMBUS mode, the value may be overwritten by an SMBus host.
2	fullPwrMgmtz	R/W	1Xh	Full Power Management. This bit is loaded at the deassertion of reset with the value of the FULLPWRMGMTz/SMBA1 terminal. 0 = Port power switching and over-current status reporting is enabled 1 = Port power switching and over-current status reporting is disabled When the TUSB4020BI is in I ² C mode, the TUSB4020BI loads this bit from the contents of the EEPROM. When the TUSB4020BI is in SMBUS mode, the value may be overwritten by an SMBus host.
1	RSVD	R/W	1Xh	Reserved. This bit is reserved and should not be altered from the default.
0	RSVD	R	1Xh	Reserved. This field is reserved and returns 0 when read.



8.6.1.7 Battery Charging Support Register (offset = 6h) [reset = 0Xh]

Figure 8-8. Register Offset 6h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	Х	X
R	R/W						

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-10. Battery Charging Support Register

Bit	Field	Туре	Reset	Description
7:2	RSVD	R	0Xh	Reserved. Read only, returns 0 when read.
1:0	batEn[1:0]	R/W	0Xh	Battery Charger Support. The bits in this field indicate whether the downstream port implements the charging port features. 0 = The port is not enabled for battery charging support features 1 = The port is enabled for battery charging support features Each bit corresponds directly to a downstream port, that is batEn0 corresponds to downstream port 1, and batEN1 corresponds to downstream port 2. The default value for these bits are loaded at the deassertion of reset with the value of PWRCTL/BATEN[1:0]. When in I2C/SMBus mode the bits in this field may be overwritten by EEPROM contents or by an SMBus host.

8.6.1.8 Device Removable Configuration Register (offset = 7h) [reset = 0Xh]

Figure 8-9. Register Offset 7h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	Х	Х
R/W	R	R	R	R	R	R	R/W

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-11. Device Removable Configuration Register

Bit	Field	Type	Reset	Description	
7	customRmbl	R/W	0Xh	Custom removable status. When this field is a 1, the TUSB4020BI uses rmbl bits in this register to identify removable status for the ports.	
6:2	RSVD	R	0Xh	Reserved. Read only, returns 0 when read. Bits 3:2 are RW. They are reserved and return 0 when read.	
1:0	rmbl[1:0]	R/W	0Xh	Removable. The bits in this field indicate whether a device attached to downstream ports 2 through 1 are removable or permanently attached. 0 = The device attached to the port is not removable 1 = The device attached to the port is removable Each bit corresponds directly to a downstream port n + 1, that is rmbl0 corresponds to downstream port 1, rmbl1 corresponds to downstream port 2, and so forth. This field is read only unless the customRmbl bit is set to 1. Otherwise the value of this filed reflects the inverted values of the OTP ROM non_rmb[1:0] field.	

8.6.1.9 Port Used Configuration Register (offset = 8h) [reset = 0h]

Figure 8-10. Register Offset 8h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1
R	R	R	R	R	R	R	R

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-12. Port Used Configuration Register

г					
	Bit	Field	Туре	Reset	Description
	7:0	RSVD	R	0h	Reserved. Read only.

8.6.1.10 PHY Custom Configuration Register (offset = 9h) [reset = 0h]

Figure 8-11. Register Offset 9h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R	R	R/W	R	R	R	R/W	R/W

LEGEND: R/W = Read/Write; R = Read only; –n = value after reset

Table 8-13. PHY Custom Configuration Register

Bit	Field	Туре	Reset	Description
7:6	RSVD	R	0h	Reserved. Read only, returns 0 when read.
5	RSVD	R/W	0h	Reserved. This bit is reserved and should not be altered from the default.
4:2	RSVD	R	0h	Reserved. Read only, returns 0 when read.
1:0	RSVD	R/W	0h	Reserved. This field is reserved and should not be altered from the default.



8.6.1.11 Device Configuration Register 2 (offset = Ah)

Figure 8-12. Register Offset Ah

7	6	5	4	3	2	1	0
0	0	X	0	0	0	0	0
R	RW	RW	RW	RW	RW	RW	R

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-14. Bit Descriptions - Device Configuration Register 2

Bit	Field Name	Access	Reset	Description
7	RSVD	RO		Reserved. Read only, returns 0 when read.
				Custom Battery Charging Feature Enable. This bit controls the ability to write to the battery charging feature configuration controls.
6	customBCfeatures	RW		0 = The HiCurAcpModeEn and AutoModeEnz bits are read only and the values are loaded from the OTP ROM.
				1 = The HiCurAcpModeEn and AutoModeEnz bits are read/write and can be loaded by EEPROM or written by SMBus. from this register.
				This bit may be written simultaneously with HiCurAcpModeEn and AutoModeEnz.
				Power enable polarity. This bit is loaded at the deassertion of reset with the inverse value of the PWRCTL_POL terminal.
				0 = PWRCTL polarity is active low
5	pwrctlPol	RW		1 = PWRCTL polarity is active high
	'			When the TUSB4020BI is in I^2C mode, the TUSB4020BI loads this bit from the contents of the EEPROM.
				When the TUSB4020BI is in SMBUS mode, the value may be overwritten by an SMBus host.
	HiCurAcpModeEn	RO/RW		High-current ACP mode enable. This bit enables the high-current tablet charging mode when the automatic battery charging mode is enabled for downstream ports.
4				0 = High current divider mode disabled
4				1 = High current divider mode enabled
3	RSVD	RW		Reserved
				DSPort ECR enable. This bit enables full implementation of the DSPORT ECR (April 2013).
2	dsportEcrEn	RW		0 = DSPort ECR (April 2013) is enabled with the exception of changes related to the CCS bit is set upon entering U0, and changes related to avoiding or reporting compliance mode entry.
				1 = The full DSport ECR (April 2013) is enabled.
				Automatic Mode Enable. This bit is loaded from the OTP ROM.
				The automatic mode only applies to downstream ports with battery charging enabled when the upstream port is not connected. Under these conditions:
				0 = Automatic mode battery charging features are enabled. Only battery charging DCP and custom BC (divider mode) is enabled.
1	autoModeEnz	RO/RW		1 = Automatic mode is disabled; only battery charging DCP and CDP mode is supported.
				Note: When the upstream port is connected, battery charging CDP mode is supported on all ports when this field is one.
				This bit is read only unless the customBCfeatures bit is set to 1. Otherwise the value of this bit reflects the value of the OTP ROM AutoModeEnz bit.
0	RSVD	RO		Reserved. Read only, returns 0 when read.

8.6.1.12 UUID Registers (offset = 10h to 1Fh)

Figure 8-13. Register Offset 10h to 1Fh

<u>_</u>				_			_
7	6	5	4	3	2	1	0
X	X	X	X	X	X	X	X
R	R	R	R	R	R	R	R

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-15. Bit Descriptions - UUID Byte N Register

Bit	Field Name	Access	Reset	Description
7:0	uuidByte[n]	RO		UUID byte N. The UUID returned in the Container ID descriptor. The value of this register is provided by the device and is meets the UUID requirements of Internet Engineering Task Force (IETF) RFC 4122 A UUID URN Namespace.

8.6.1.13 Language ID LSB Register (offset = 20h)

Figure 8-14. Register Offset 20h

7	6	5	4	3	2	1	0
0	0	0	0	1	0	0	1
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-16. Bit Descriptions - Language ID LSB Register

Bit	Field Name	Access	Reset	Description
7:0	langldLsb	RW		Language ID least significant byte. This register contains the value returned in the LSB of the LANGID code in string index 0. The TUSB4020BI only supports one language ID. The default value of this register is 09h representing the LSB of the LangID 0409h indicating English United States. When customStrings is 1, this field may be overwritten by the contents of an attached EEPROM or by an SMBus host.

8.6.1.14 Language ID MSB Register (offset = 21h)

Figure 8-15. Register Offset 21h

			,	J			
7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-17. Bit Descriptions - Language ID MSB Register

Bit	Field Name	Access	Reset	Description
7:0	langIdMsb	RO/RW		Language ID most significant byte. This register contains the value returned in the MSB of the LANGID code in string index 0. The TUSB4020BI only supports one language ID. The default value of this register is 04h representing the MSB of the LangID 0409h indicating English United States. When customStrings is 1, this field may be overwritten by the contents of an attached EEPROM or by an SMBus host.



8.6.1.15 Serial Number String Length Register (offset = 22h)

Figure 8-16. Register Offset 22h

7	6	5	4	3	2	1	0
0	0	0	1	1	0	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-18. Bit Descriptions - Serial Number String Length Register

Bit	Field Name	Access	Reset Description	
7:6	RSVD	RO		Reserved. Read only, returns 0 when read.
5:0	serNumStringLen	RO/RW		Serial number string length. The string length in bytes for the serial number string. The default value is 18h indicating that a 24-byte serial number string is supported. The maximum string length is 32 bytes. When customSernum is 1, this field may be overwritten by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a serial number string of serNumbStringLen bytes is returned at string index 1 from the data contained in the Serial Number String registers.

8.6.1.16 Manufacturer String Length Register (offset = 23h)

Figure 8-17. Register Offset 23h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R	R/W						

LEGEND: R/W = Read/Write; R = Read only; –n = value after reset

Table 8-19. Bit Descriptions - Manufacturer String Length Register

Bit	Field Name	Access	Reset	Description
7	RSVD	RO		Reserved. Read only, returns 0 when read.
6:0	mfgStringLen	RO/RW		Manufacturer string length. The string length in bytes for the manufacturer string. The default value is 0, indicating that a manufacturer string is not provided. The maximum string length is 64 bytes. When customStrings is 1, this field may be overwritten by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a manufacturer string of mfgStringLen bytes is returned at string index 3 from the data contained in the Manufacturer String registers.

8.6.1.17 Product String Length Register (offset = 24h)

Figure 8-18. Register Offset 24h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R	R/W						

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-20. Bit Descriptions - Product String Length Register

Bit	Field Name	Access	Reset	Description
7	RSVD	RO		Reserved. Read only, returns 0 when read.
6:0	prodStringLen	RO/RW		Product string length. The string length in bytes for the product string. The default value is 0, indicating that a product string is not provided. The maximum string length is 64 bytes. When customStrings is 1, this field may be overwritten by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a product string of prodStringLen bytes is returned at string index 2 from the data contained in the Product String registers.

8.6.1.18 Serial Number Registers (offset = 30h to 4Fh)

Figure 8-19. Register Offset 30h to 4Fh

7	6	5	4	3	2	1	0
Х	X	x	х	x	х	х	x
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-21. Bit Descriptions - Serial Number Registers

Bit	Field Name	Access	Reset	Description
7:0	serialNumber[n]	RO/RW		Serial Number byte N. The serial number returned in the Serial Number string descriptor at string index 1. The default value of these registers is set by TI. When customSernum is 1, these registers may be overwritten by EEPROM contents or by an SMBus host.

8.6.1.19 Manufacturer String Registers (offset = 50h to 8Fh)

Figure 8-20. Register Offset 50h to 8Fh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-22. Bit Descriptions – Manufacturer String Registers

Bit	Field Name	Access	Reset	Description
7:0	mfgStringByte[n]	RO/RW		Manufacturer string byte N. These registers provide the string values returned for string index 3 when mfgStringLen is greater than 0. The number of bytes returned in the string is equal to mfgStringLen. The programmed data should be in UNICODE UTF-16LE encodings as defined by The Unicode Standard, Worldwide Character Encoding, Version 5.0.



8.6.1.20 Product String Registers (offset = 90h to CFh)

Figure 8-21. Register Offset 90h to CFh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R/W							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-23. Bit Descriptions - Product String Byte N Register

			<u> </u>	
Bit	Field Name	Access	Reset	Description
7:0	prodStringByte[n]	RW		Product string byte N. These registers provide the string values returned for string index 2 when prodStringLen is greater than 0. The number of bytes returned in the string is equal to prodStringLen. The programmed data should be in UNICODE UTF-16LE encodings as defined by The Unicode Standard, Worldwide Character Encoding, Version 5.0.

8.6.1.21 Additional Feature Configuration Register (offset = F0h)

Figure 8-22. Register Offset F0h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R	R/W						

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-24. Bit Descriptions - Additional Feature Configuration Register

Bit	Field Name	Access	Reset	Description
7:1	RSVD	RO		Reserved. Read only, returns 0 when read.
0	RSVD	RW		Reserved
				This bit is loaded at the deassertion of reset with the value of the SCL/SMBCLK terminal.

8.6.1.22 Charging Port Control Register (offset = F2h)

Figure 8-23. Register Offset F2h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R	R	R	R	R/W	R/W	R/W	R/W

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-25. Bit Descriptions - Charging Port Control Register

Bit	Field Name	Access	Reset	Description			
7:4	RSVD	RO		Reserved. Read only, returns 0 when read.			
3:1	pwronTime	RW		Power-On Delay Time. When dsportEcrEn is set, this field sets the delay time from the removal disable of PWRCTL to the enable of PWRCTL when transitioning battery charging modes. For example, when disabling the power on a transition from custom charging mode to Dedicated Charging Port Mode. The nominal timing is defined as follows: TPWRON_EN = (pwronTime + 1) × 200 ms (1) These registers may be overwritten by EEPROM contents or by an SMBus host.			
0	RSVD	RW		Reserved. This bit is reserved and should not be altered from the default.			



8.6.1.23 Device Status and Command Register (offset = F8h)

Figure 8-24. Register Offset F8h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R	R	R	R	R	R	RSU	RCU

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 8-26. Bit Descriptions - Device Status and Command Register

Bit	Field Name	Access	Reset Description							
7:2	RSVD	R		Reserved. Read only, returns 0 when read.						
1	smbusRst	RSU		SMBus interface reset. This bit loads the registers back to their GRSTz values. This bit is set by writing a 1 and is cleared by hardware on completion of the reset. A write of 0 has no effect.						
0	Control of the contro			Configuration active. This bit indicates that configuration of the TUSB4020BI is currently active. The bit is set by hardware when the device enters the I ² C or SMBus mode. The TUSB4020BI will not connect on the upstream port while this bit is 1. When in the SMBus mode, this bit must be cleared by the SMBus host to exit the configuration mode and allow the upstream port to connect. The bit is cleared by a writing 1. A write of 0 has no effect.						

9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9.1 Application Information

The TUSB4020BI is a two-port USB 2.0 hub. It provides USB high-speed/full-speed connections on the upstream port and provides USB high-speed, full-speed, or low-speed connections on the downstream port. The TUSB4020BI can be used in any application that needs additional USB compliant ports. For example, a specific notebook may only have two downstream USB ports. By using the TUSB4020BI, the notebook can increase the downstream port count to three.

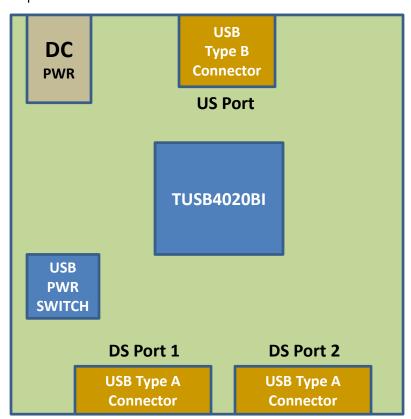


Figure 9-1. Discrete USB Hub Product

9.1.1 Crystal Requirements

The crystal must be fundamental mode with load capacitance of 12 to 24 pF and frequency stability rating of ± 100 PPM or better. To ensure proper startup oscillation condition, TI recommends a maximum crystal equivalent series resistance (ESR) of 50 Ω . A parallel load capacitor should be used if a crystal source is used. The exact load capacitance value used depends on the crystal vendor. Refer to application note *Selection and Specification of Crystals for Texas Instruments USB 2.0 Devices* for details on how to determine the load capacitance value.

9.1.2 Input Clock Requirements

When using an external clock source such as an oscillator, the reference clock should have a ±100 PPM or better frequency stability and have less than 50-ps absolute peak-to-peak jitter. XI should be tied to the 1.8-V clock source and XO should be left floating.

9.2 Typical Applications

A common application for the TUSB4020BI is as a self-powered standalone USB hub product. The product is powered by an external 5-V DC power adapter. In this application using a USB cable, TUSB4020BI device's upstream port is plugged into a USB host controller. The downstream ports of the TUSB4020BI are exposed to users for connecting USB hard drives, camera, flash drive, and so forth.

9.2.1 Upstream Port Implementation

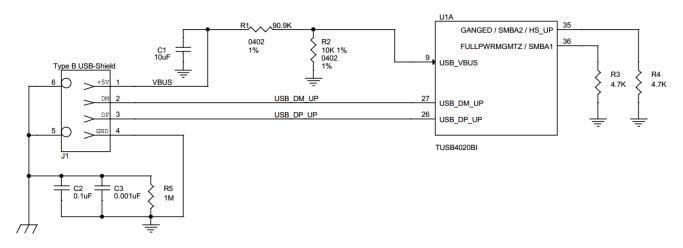


Figure 9-2. Upstream Port Implementation Schematic

9.2.1.1 Design Requirements

Table 9-1. Input Parameters

DESIGN PARAMETER	EXAMPLE VALUE
VDD supply	1.1 V
VDD33 supply	3.3 V
Upstream port USB support (HS, FS)	HS, FS
Downstream port 1 USB support (HS, FS, LS)	HS, FS, LS
Downstream port 2 USB support (HS, FS, LS)	HS, FS, LS
Number of removable downstream ports	2
Number of non-removable downstream ports	0
Full power management of downstream ports	Yes (FULLPWRMGMTZ = 0)
Individual control of downstream port power switch	Yes (GANGED = 0)
Power switch enable polarity	Active high (PWRCTL_POL = 0)
Battery charge support for downstream port 1	Yes
Battery charge support for downstream port 2	Yes
I ² C EEPROM support	No
24-MHz clock source	Crystal



9.2.1.2 Detailed Design Procedure

The upstream of the TUSB4020BI is connected to a USB2 type B connector. This particular example has GANGED terminal and FULLPWRMGMTZ terminal pulled low, which results in individual power support each downstream port. The VBUS signal from the USB2 type B connector is fed through a voltage divider. The purpose of the voltage divider is to make sure the level meets USB_VBUS input requirements.

9.2.1.3 Application Curves

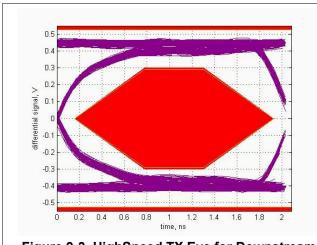


Figure 9-3. HighSpeed TX Eye for Downstream Port 1

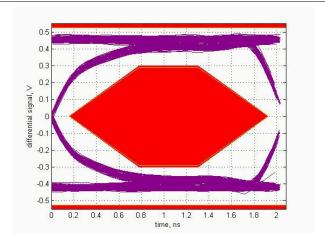


Figure 9-4. HighSpeed TX Eye for Downstream Port 2

9.2.2 Downstream Port 1 Implementation

The downstream port 1 of the TUSB4020BI is connected to a USB2 type A connector. With BATEN1 terminal pulled up, battery charge support is enabled for port 1. If battery charge support is not needed, then the pullup resistor on BATEN1 should be uninstalled. The PWRCTL_POL is pulled-down, which results in active-high power enable (PWRCTL1 and PWRCTL2) for a USB VBUS power switch.

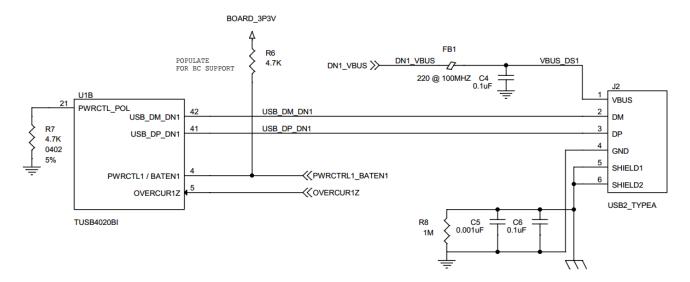


Figure 9-5. Downstream Port 1 Implementation Schematic

9.2.3 Downstream Port 2 Implementation

The downstream port 2 of the TUSB4020BI is connected to a USB2 type A connector. With BATEN2 terminal pulled up, battery charge support is enabled for port 2. If battery charge support is not needed, then the pullup resistor on BATEN2 should be uninstalled.

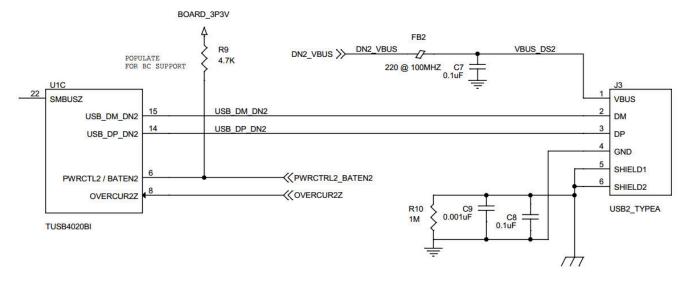


Figure 9-6. Downstream Port 2 Implementation Schematic

9.2.4 VBUS Power Switch Implementation

This particular example uses the TI TPS2561 dual-channel precision adjustable current-limited power switch. For details on this power switch or other power switches available from TI, refer to www.ti.com.

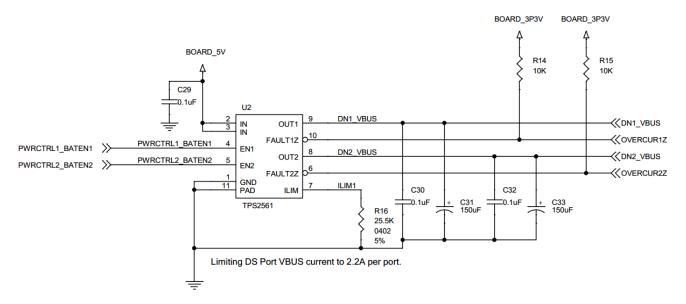


Figure 9-7. Power Switch Implementation Schematic

9.2.5 Clock, Reset, and Miscellaneous

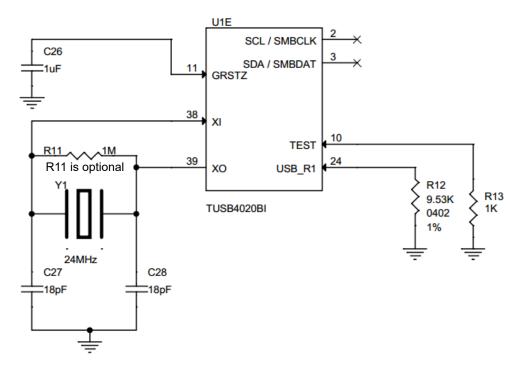


Figure 9-8. Clock, Reset, and Miscellaneous Schematic

9.2.6 Power Implementation

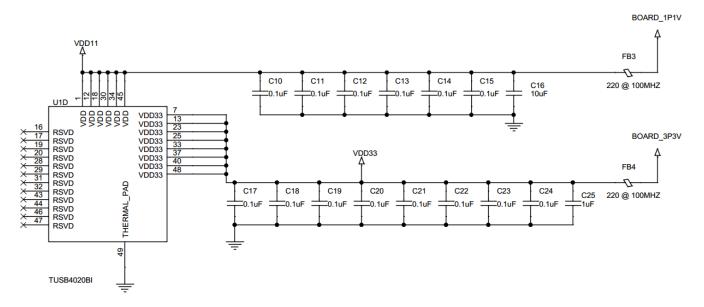


Figure 9-9. Power Implementation Schematic



10 Power Supply Recommendations 10.1 Power Supply

 V_{DD} should be implemented as a single power plane, as should V_{DD33} .

- The V_{DD} terminals of the TUSB4020BI supply 1.1-V (nominal) power to the core of the TUSB4020BI. This power rail can be isolated from all other power rails by a ferrite bead to reduce noise.
- The DC resistance of the ferrite bead on the core power rail can affect the voltage provided to the device due to the high current draw on the power rail. The output of the core voltage regulator may need to be adjusted to account for this or a ferrite bead with low DC resistance (less than 0.05 Ω) can be selected.
- The V_{DD33} terminals of the TUSB4020BI supply 3.3-V power rail to the I/O of the TUSB4020BI. This power rail can be isolated from all other power rails by a ferrite bead to reduce noise.
- All power rails require a 10-μF capacitor or 1-μF capacitors for stability and noise immunity. These bulk capacitors can be placed anywhere on the power rail. The smaller decoupling capacitors should be placed as close to the TUSB4020BI power pins as possible with an optimal grouping of two of differing values per pin.

10.2 Downstream Port Power

- The downstream port power, VBUS, must be supplied by a source capable of supplying 5 V and at least 500 mA per port. Downstream port power switches can be controlled by the TUSB4020BI signals. It is possible to leave the downstream port power always enabled.
- Each downstream port's VBUS requires a large bulk low-ESR capacitor of 22 µF or larger to limit in-rush current.
- TI recommends ferrite beads on the VBUS pins of the downstream USB port connections for both ESD and EMI reasons. A 0.1-µF capacitor on the USB connector side of the ferrite provides a low-impedance path to ground for fast rise time ESD current that might have coupled onto the VBUS trace from the cable.

10.3 Ground

TI recommends to use only one board ground plane in the design. This provides the best image plane for signal traces running above the plane. The thermal pad of the TUSB4020BI and any of the voltage regulators should be connected to this plane with vias. An earth or chassis ground is only implemented near the USB port connectors on a different plane for EMI and ESD purposes.

11 Layout

11.1 Layout Guidelines

11.1.1 Placement

- 1. A 9.53-k Ω ±1% resistor connected to terminal USB_R1 should be placed as close as possible to the TUSB4020BI.
- 2. A 0.1-μF capacitor should be placed as close as possible on each V_{DD} and V_{DD33} power pin.
- 3. The ESD and EMI protection devices (if used) should also be placed as possible to the USB connector.
- 4. If a crystal is used, it must be placed as close as possible to the TUSB4020BI device's XI and XO terminals.
- 5. Place voltage regulators as far away as possible from the TUSB4020BI, crystal, and differential pairs.
- 6. In general, the large bulk capacitors associated with each power rail should be placed as close as possible to the voltage regulators.

11.1.2 Package Specific

- 1. The TUSB4020BI package has a 0.5-mm pin pitch.
- 2. The TUSB4020BI package has a 3.6-mm × 3.6-mm thermal pad. This thermal pad must be connected to ground through a system of vias.
- 3. All vias under device, except for those connected to thermal pad, should be solder masked to avoid potential issues with thermal pad layouts.

11.1.3 Differential Pairs

This section describes the layout recommendations for all of the TUSB4020BI differential pairs: USB_DP_XX, USB_DM_XX.

- Must be designed with a differential impedance of 90 Ω ±10%.
- To minimize crosstalk, TI recommends to keep high-speed signals away from each other. Each pair should be separated by at least 5× the signal trace width. Separating with ground as depicted in the layout example also helps minimize crosstalk.
- Route all differential pairs on the same layer adjacent to a solid ground plane.
- · Do not route differential pairs over any plane split.
- Adding test points causes impedance discontinuity, and therefore, negatively impacts signal performance. If
 test points are used, they should be placed in series and symmetrically. They must not be placed in a manner
 that causes stub on the differential pair.
- Avoid 90° turns in trace. The use of bends in differential traces should be kept to a minimum. When bends are used, the number of left and right bends should be as equal as possible and the angle of the bend should be ≥135°. Taking this action minimizes any length mismatch caused by the bends, and therefore, minimizes the impact bends have on EMI.
- Minimize the trace lengths of the differential pair traces. Eight inches is the maximum recommended trace length for USB 2.0 differential-pair signals. Longer trace lengths require very careful routing to assure proper signal integrity.
- Match the etch lengths of the differential pair traces (that is DP and DM). The USB 2.0 differential pairs should not exceed 50-mils relative trace length difference.
- Minimize the use of vias in the differential-pair paths as much as possible. If this is not practical, ensure that
 the same via type and placement are used for both signals in a pair. Any vias used should be placed as close
 as possible to the TUSB4020BI device.
- Do not place power fuses across the differential-pair traces.



11.2 Layout Example

Figure 11-1 shows an example layout of the upstream port to a USB3 Type B connector. The routing to a USB2 Type B connector will be similar.

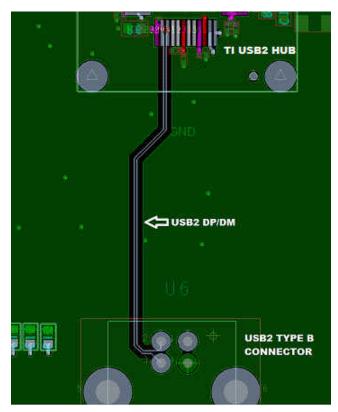


Figure 11-1. Upstream Port

Figure 11-2 shows an example layout of the Downstream Port to a USB3 Type A connector. The routing to a USB2 Type A connector will be similar.

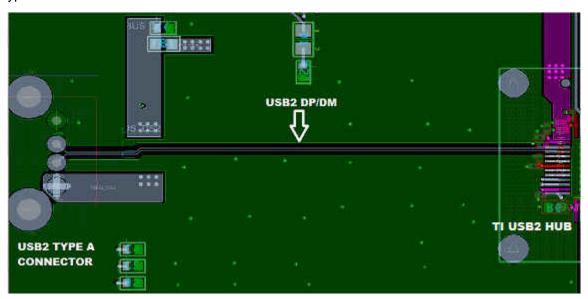


Figure 11-2. Downstream Port

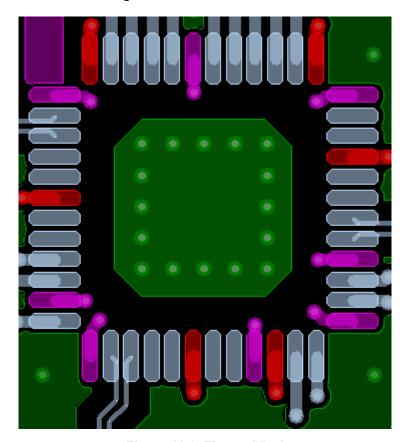


Figure 11-3. Thermal Pad



12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

12.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com 14-Dec-2021

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TUSB4020BIPHP	ACTIVE	HTQFP	PHP	48	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	T4020BI	Samples
TUSB4020BIPHPR	ACTIVE	HTQFP	PHP	48	1000	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	T4020BI	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TUSB4020BI:

Automotive: TUSB4020BI-Q1

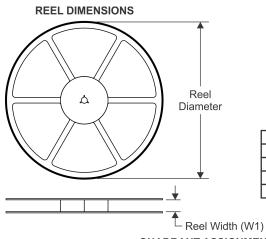
NOTE: Qualified Version Definitions:

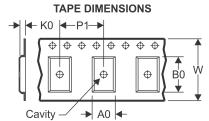
• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

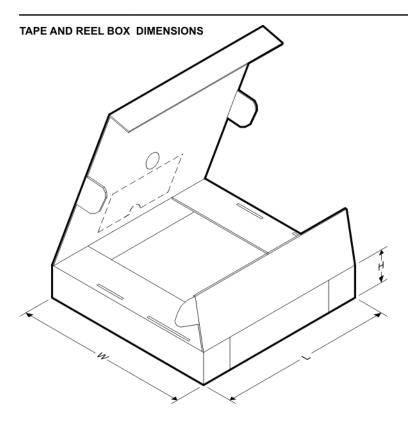


*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TUSB4020BIPHPR	HTQFP	PHP	48	1000	330.0	16.4	9.6	9.6	1.5	12.0	16.0	Q2

PACKAGE MATERIALS INFORMATION

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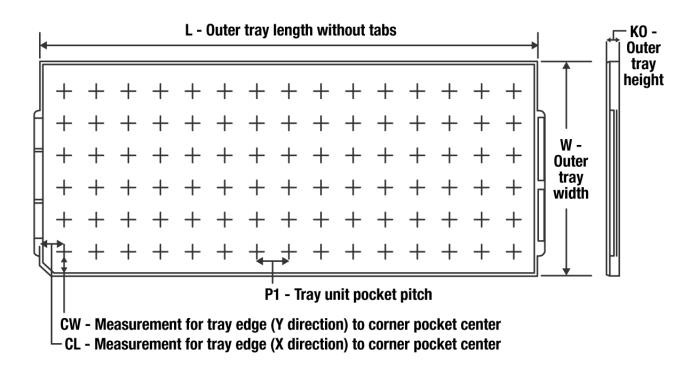
*All dimensions are nominal

ĺ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	TUSB4020BIPHPR	HTQFP	PHP	48	1000	336.6	336.6	31.8



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TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

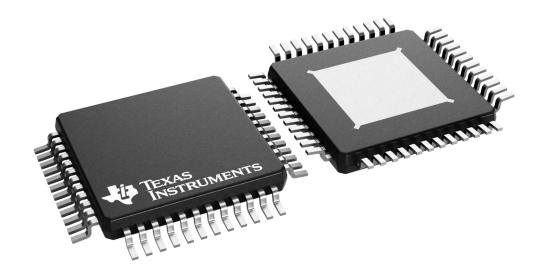
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	Κ0 (μm)	P1 (mm)	CL (mm)	CW (mm)
TUSB4020BIPHP	PHP	HTQFP	48	250	10 x 25	150	315	135.9	7620	12.2	11.1	11.25

7 x 7, 0.5 mm pitch

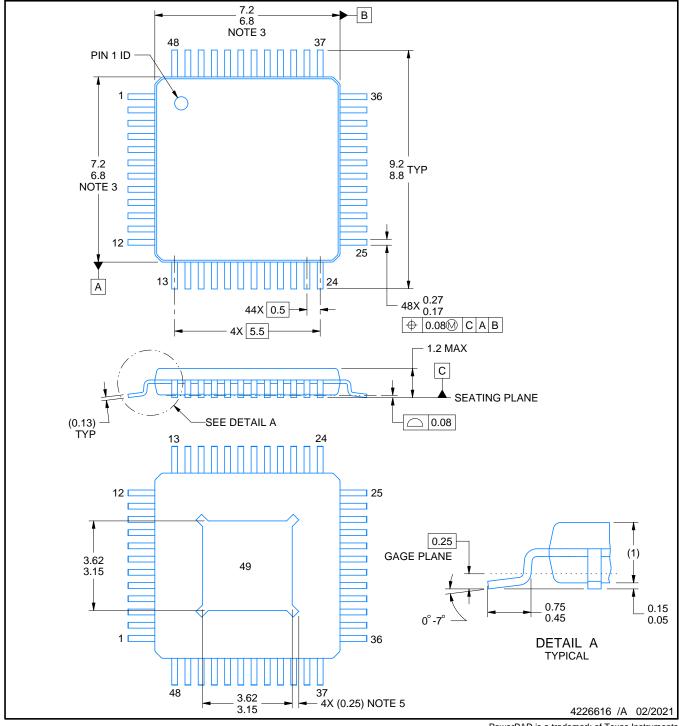
QUAD FLATPACK

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



PowerPAD™ HTQFP - 1.2 mm max height



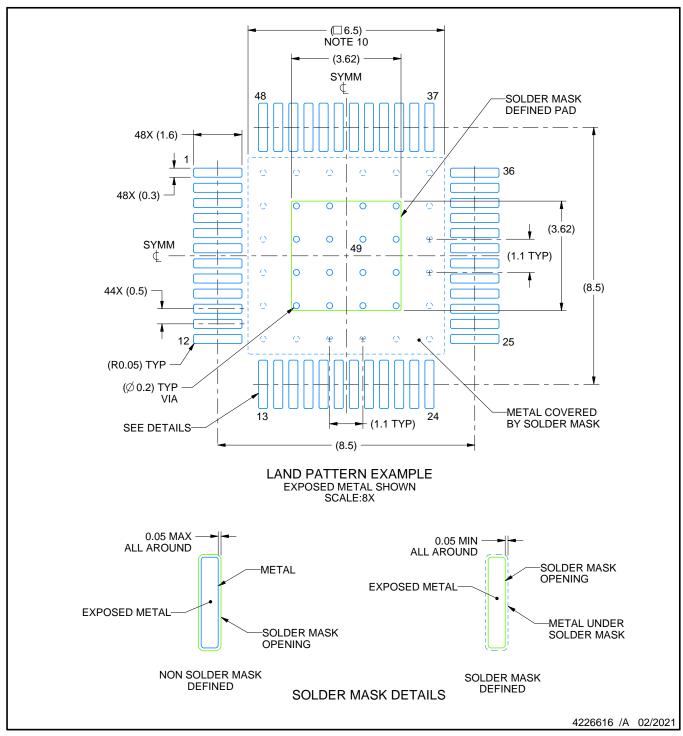


NOTES:

PowerPAD is a trademark of Texas Instruments.

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
 4. Reference JEDEC registration MS-026.
 5. Feature may not be present.

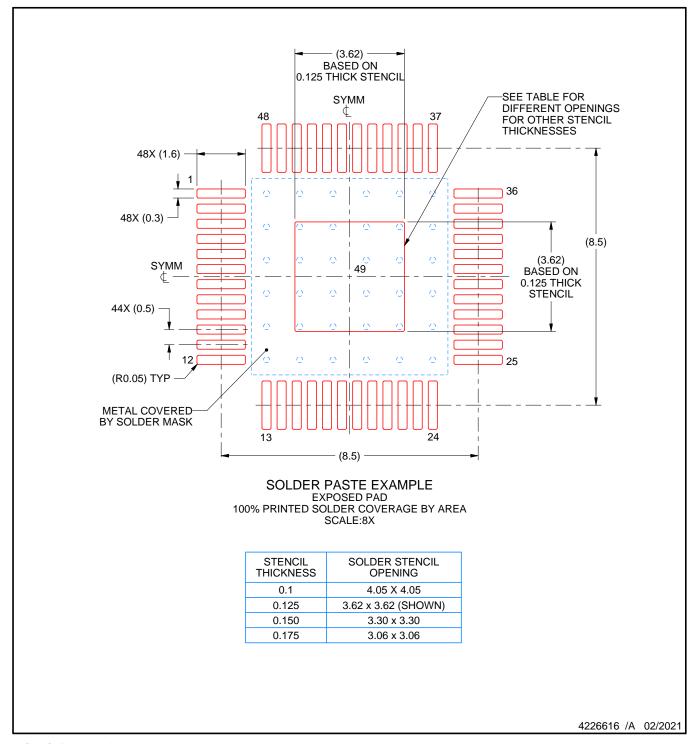




NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
- 8. This package is designed to be soldered to a thermal pad on the board. See technical brief, Powerpad thermally enhanced package, Texas Instruments Literature No. SLMA002 (www.ti.com/lit/slma002) and SLMA004 (www.ti.com/lit/slma004).
- 9. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.
- 10. Size of metal pad may vary due to creepage requirement.





NOTES: (continued)



^{11.} Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

^{12.} Board assembly site may have different recommendations for stencil design.

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